# AN6371, AN6371S

## VTR Color APC Circuits

#### Outline

The AN6371 and The AN6371S are integrated circuits designed for VTR corol APC constitute a VTR PAL-system color signal processing circuit by combining with the AN6360, the AN6363 or the 6363S.

#### **■** Features

• The functions consist of :

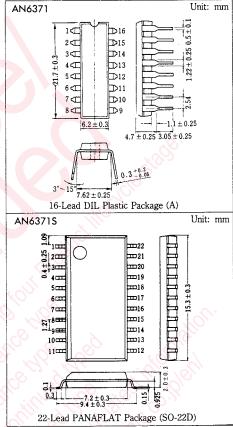
APC circuit

Color-killer circuit

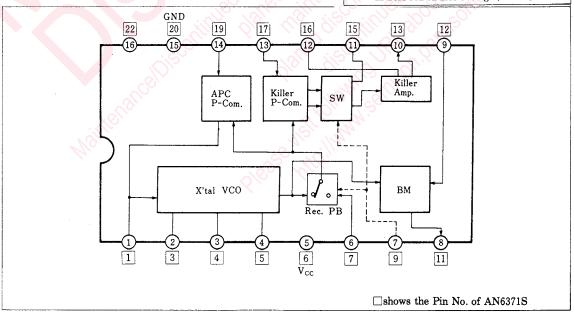
Balanced modulator

ID detector

Supply voltage either 9V or 12V



#### Block Diagram



## Pin

( ) shows the Pin No. of AN6371S

Pin No.	Pin Name	Pin No.	Pin Name		
1(1)	APC Filter	9 (12)	627kHz Input		
2 (3)		10 (13)	Killer Output		
3 (4)	X'tal Oscillator	11 (15)	ID Detect		
4 (5)		12 (16)	Killer Detect		
5 (6)	Vcc	13 (17)	Killer Burst Input		
6 (7)	4.43MHz Input	14 (19)	APC Burst Input		
7 (9)	Rec./P.B. Select	15 (20)	GND		
8 (11)	5.06MHz Output	16 (22)	Killer Filter		

In case of AN6371S, Pin No.2, 8, 10, 14, 18, 20 are NC.

## ■ Absolute Maximum Ratings (T<sub>a</sub>=25°C)

Item	Symbol	Rating	Unit	
Supply voltage	$V_{cc}$	14.4	V	
Power dissipation AN6371	D	550	mW	
(Ta=70°C) AN6371S	P <sub>D</sub>	270*		
Operating ambient temperature	$T_{opr}$	-20~+70	°C	
Storage AN6371	T	-40~+150		
temperature AN6371S	$T_{ m stg}$	-40~+125	°C	

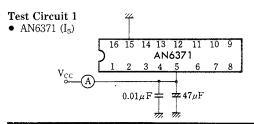
<sup>\*</sup>Indicates a package capability.

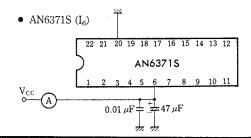
## ■ Electrical Characteristics $(V_{CC} = 12V, Ta = 25^{\circ}C \pm 2^{\circ}C)$

Item		Symbol	Test Circuit	Condition	min.	typ.	max.	Unit
Circuit current	AN6371 AN6371S	$I_5$ $I_6$	1	963 1461 16 13 9 12	20		40	mA
X'tal VCO frequency control sensitivity	AN6371 AN6371S	$\beta_8$ $\beta_{11}$	2	of Way Way the File	7.2	રું ડ	17.3	Hz/mV
APC P-COM discrimination sensitivity		$\mu_1$	4	Burst 1V <sub>P-P</sub>	9.5	10.	26	mV/deg
Color killer sensitivity ON		S <sub>(B/W)</sub>	4	H→L	-8		-3.3	dB
Color killer sensitivity OFF		S <sub>(Color)</sub>	4	L-→H	, S.		-2.8	dB
Color killer output (H)	AN6371 AN6371S	$V_{10-H} \ V_{13-H}$	4	160 COL 187	9			V
Color killer output (L)	AN6371 AN6371S	$V_{10-L}$ $V_{13-L}$	4	913, 913, 90, 90			0.5	V
180° ID detection phase	AN6371 AN6371S	S <sub>(ID)13</sub> S <sub>(ID)17</sub>	4	Burst 1V <sub>P-P</sub>	150		230	deg
BM output amplitude AN6371 AN6371S		$v_{08} = v_{011}$	3	" (O) " (O) " (S) "	.1.4		2	V <sub>P-P</sub>
Carrier leak	AN6371 AN6371S	CL <sub>8</sub> CL <sub>11</sub>	3	is who			-30	dB
Rec./PB select sensitivity	AN6371 AN6371S	S <sub>7</sub> S <sub>9</sub>	5	25° 710'.),	3			V

Note) X'tal is for 3.58MHz. Asignal is an NTSC signal.

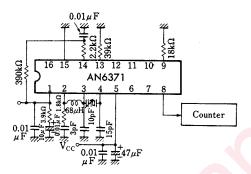
Operating supply voltage range V<sub>CC(opr)</sub>=8.5~13V





## Test Circuit 2

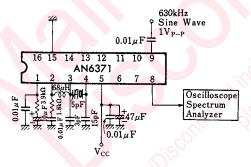
• AN6371( $\beta_{8}$ )



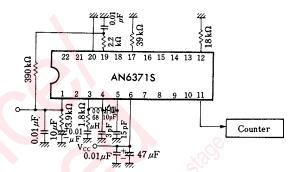
- Note 1) Adjust the Pin 3 trimmer so that a Pin 8 output frequency will be 3.579545 MHz.
- Note 2) Frequency difference in case of  $\pm$  100 mV to a Pin ① voltage  $g = \frac{f(+100\text{mV}) f(-100\text{mV})}{(-100\text{mV})}$

## Test Circuit 3

• AN6371 ( v os, CL<sub>8</sub>)



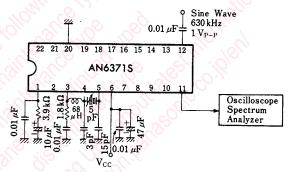
## • AN6371S( $\beta_{11}$ )



- Note 1) Adjust the Pin ① trimmer so that a Pin ① output frequency will be 3.57 9545 MHz.
  - Frequency in case of ±100 mV to a Pin ① voltage

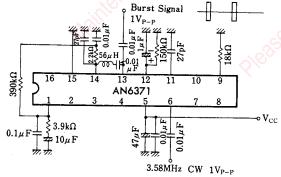
$$\beta = \frac{f(+100 \,\mathrm{mV}) - f(-100 \,\mathrm{mV})}{200}$$

• AN6371S( v on, CL11)

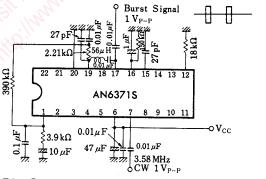


## Test Circuit 4

• AN6371( $\mu_1$ ,  $S_{(B/W)}$ ,  $S_{(Color)}$ ,  $V_{10-H}$ ,  $V_{10-L}$ ,  $S_{(ID)13}$ ) • AN6371S( $\mu_1$ ,  $S_{(B/W)}$ ,  $S_{(Color)}$ ,  $V_{13-H}$ ,  $V_{13-L}$ ,  $S_{(ID)17}$ )



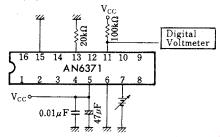
Note) Pin (3) and (6) siganals are locked ones.



Pin @ and @ are locked ones.

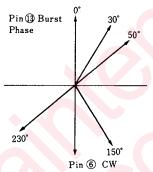
## Test Circuit 5

• AN6371(S<sub>1</sub>)



Note)Pin 7 voltage when a Pin 1 voltage is changed from L to H

#### Burst Phase Diagram



# · APC P-COM( $\mu_1$ )

Assume that a Pin ① voltage is  $V_1$  when a Pin ③ burst input signal(|  $V_p$ -p) has a 50° phase(see a burst phase diagram), and that it is  $V_2$  when having a 30° phase, and obtain out of  $V_1$ - $V_2/20$ .

· Color killer sensitivity ON(S(B/W))

Pin ③ input amplitude when a Pin ⑥ output voltage is turned from H to L by lowering a Pin ⑤ input amplitude (b-urst phase O\*)

· Color killer sensitivity OFF(S(color))

Pin ③ input amplitude when the Pin ⑥ output voltage is turned from L to H by raising the Pin ⑤ input amplitude (b-urst phase O°)

· Color killer output(H)

Pin 10 voltage when Pin 13 input is I Vp-p

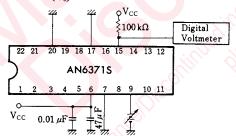
· Color killer output(L)

Pin <sup>®</sup> voltage when Pin <sup>®</sup> input is turned off

· 180° ID detection phase (S(ID)13)

Phase which causes a Pin ® output voltage to be changed by changing a Pin ® input phase

#### • AN6371S(S<sub>9</sub>)



Pin (9) voltage when a Pin (15) voltage is changed from L to H

Burst Phase Diagram or Pin ® Burst Phase 50°

230

Pin ® CW

#### · APC P-COM( $\mu_1$ )

Assume the Pin ① voltage is  $V_1$  when a Pin ② burst input signal(1  $V_p$ -p)has a 50° phase(see the burst phase diagram), and that it is  $V_2$  when having a 30° phase, and obtain out of  $V_1$ - $V_2$ /20.

· Color killer sensitivity ON(S(B/W))

Pin ① input amplitude when a Pin ② output voltage is turned from H to L lowering a Pin ② input amplitude(burst phase 0°)

· Color killer sensitivity OFF(S<sub>(color)</sub>)

Pin ① input amplitude when the Pin ③ output voltage is turued from L to H by raising the Pin ① input amplitude(burst phase 0°)

· Color killer output(H)(V<sub>13-H</sub>)

Pin 13 voltage when Pin 17 input is l Vp-p

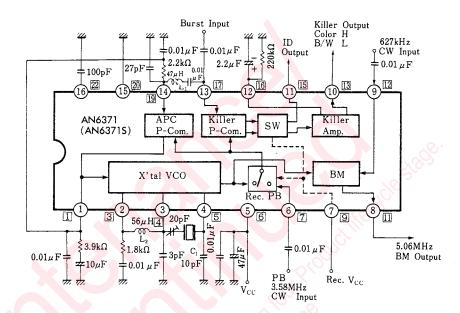
· Color killer output(L)(V<sub>13-L</sub>)

Pin (3) voltage when Pin (7) input is OFF

· 180° ID detection phase(S(ID)17)

Phase where a Pin 1 output voltage is changed a Pin 1 input phase

## Application Circuit



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